

N-Channel 700V (D-S) Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	700			
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V 0.97			
Q _g max. (nC)	40			
Q _{gs} (nC)	4			
Q _{gd} (nC)	20			
Configuration	Single			

FEATURES

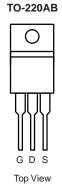
• Low figure-of-merit (FOM) Ron x Qa

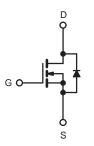


- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial





N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	700	V	
Gate-Source Voltage			V_{GS}	± 30	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
Continuous Prain Current /T 150 °C\	V _{GS} at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	I _D	10		
Continuous Drain Current (T _J = 150 °C)	VGS at 10 V	T _C = 100 °C		8.4	Α	
Pulsed Drain Current ^a			I _{DM}	36	1	
Linear Derating Factor				3.6	W/°C	
Single Pulse Avalanche Energy b			E _{AS}	280	mJ	
Maximum Power Dissipation			P_{D}	97	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope	T _J = 125 °C		15	\//r-		
Reverse Diode dV/dt ^d			dV/dt	4.1	- V/ns	
Soldering Recommendations (Peak Temperature) c for 10 s			300	°C		

- a. Repetitive rating; pulse width limited by maximum junction temperature. b. $V_{DD}=50$ V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 4.5 A.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, dI/dt = 100 A/ μ s, starting $T_J = 25$ °C.



THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-	60	°C/W		
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.8	G/ VV		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		-					•
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	700	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.75	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		-	4	V
			V _{GS} = ± 20 V	-	-	± 100	nA
Gate-Source Leakage	I_{GSS}	$V_{GS} = \pm 30 \text{ V}$		-	-	± 1	μΑ
			$V_{DS} = 700 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 560 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$		-	1	
Zero Gate Voltage Drain Current	I_{DSS}				-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		-	0.97	-	Ω
Forward Transconductance	9 _{fs}	V _{DS}	s = 30 V, I _D = 8 A	-	16	-	S
Dynamic		•					
Input Capacitance	C _{iss}		V _{GS} = 0 V,	-	850	-	
Output Capacitance	Coss	1	$V_{DS} = 0 V$, $V_{DS} = 100 V$,	-	80	-	1
Reverse Transfer Capacitance	C _{rss}	7	f = 1 MHz		10	-	pF
Effective Output Capacitance, Energy Related ^a	C _{o(er)}			-	63	-	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	$V_{DS} = 0.0$	$V_{DS} = 0 \text{ V to } 560 \text{ V}, V_{GS} = 0 \text{ V}$		213	-	
Total Gate Charge	Qg			-	43	-	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 8 \text{ A}, V_{DS} = 560 \text{ V}$		5	-	nC
Gate-Drain Charge	Q _{gd}	1		-	22	-	1
Turn-On Delay Time	t _{d(on)}	V _{DD} = 560 V, I _D = 8 A,		-	13	25	
Rise Time	t _r			-	11	35	ns
Turn-Off Delay Time	t _{d(off)}		$V_{GS} = 360 \text{ V}, I_D = 8 \text{ A},$ $V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		81	90	
Fall Time	t _f				25	40	
Gate Input Resistance	R_g	f = 1	f = 1 MHz, open drain		3.5	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	15	_
Pulsed Diode Forward Current	I _{SM}			-	-	40	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 8 A, V _{GS} = 0 V		-	-	1.5	V
Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = I _S = 8 A, dl/dt = 100 A/µs, V _R = 400 V		-	345	-	ns
Reverse Recovery Charge	Q _{rr}			_	4.5	-	μC
Reverse Recovery Current	I _{RRM}				35	<u> </u>	A

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

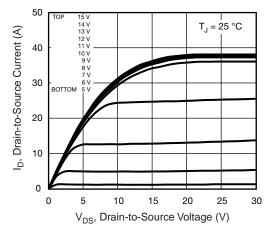


Fig. 1 - Typical Output Characteristics

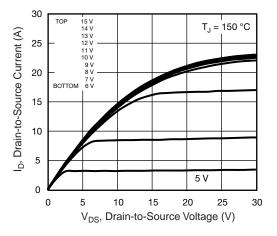


Fig. 2 - Typical Output Characteristics

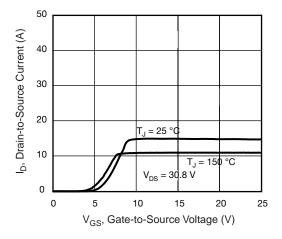


Fig. 3 - Typical Transfer Characteristics

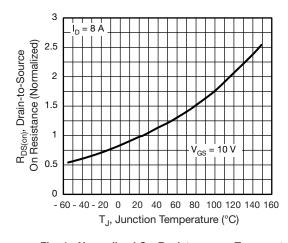


Fig. 4 - Normalized On-Resistance vs. Temperature

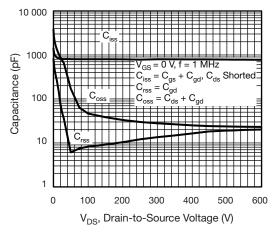


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

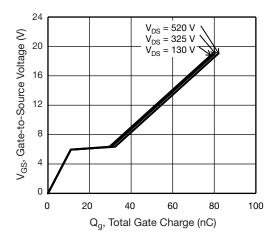


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



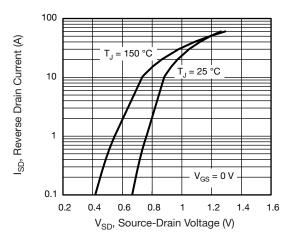


Fig. 7 - Typical Source-Drain Diode Forward Voltage

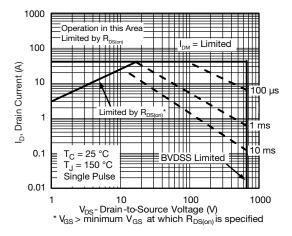


Fig. 8 - Maximum Safe Operating Area

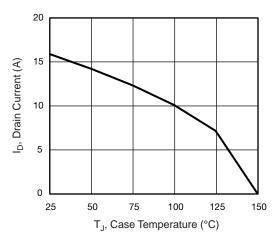


Fig. 9 - Maximum Drain Current vs. Case Temperature

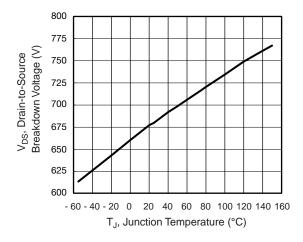


Fig. 10 - Temperature vs. Drain-to-Source Voltage

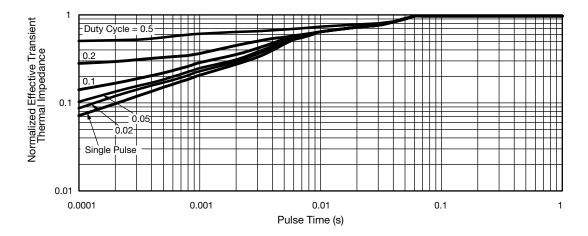


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



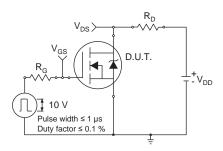


Fig. 12 - Switching Time Test Circuit

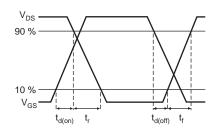


Fig. 13 - Switching Time Waveforms

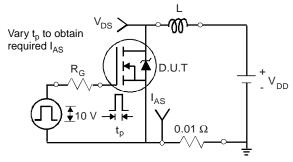


Fig. 14 - Unclamped Inductive Test Circuit

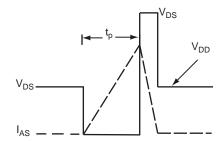


Fig. 15 - Unclamped Inductive Waveforms

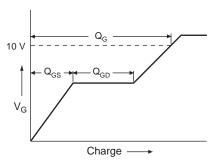


Fig. 16 - Basic Gate Charge Waveform

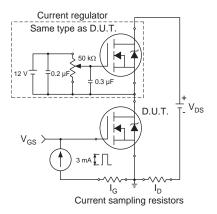
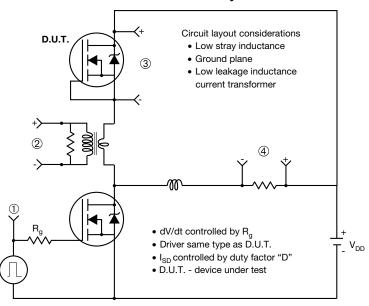


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



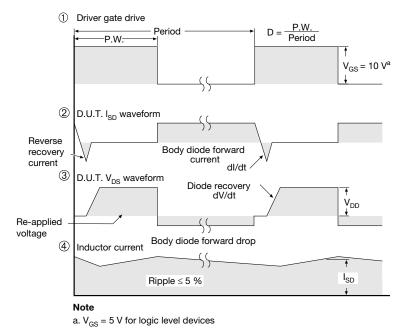
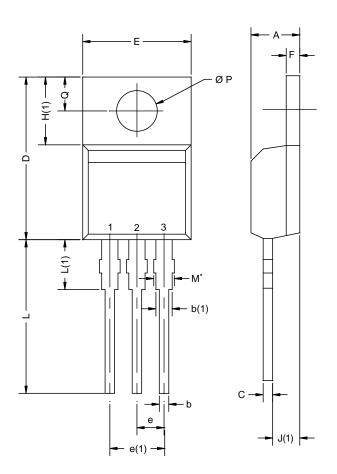


Fig. 18 - For N-Channel



TO-220AB



	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØР	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
ECN: X12-0208-Rev. N, 08-Oct-12					

DWG: 5471

Notes

 * M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM

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